Request for Quote and Specifications of gallium oxide (Ga₂O₃) epi-wafer

- Bids are sought from qualified <u>International vendors under global tender</u> for gallium oxide (Ga₂O₃) epi-wafers on Ga₂O₃ substrate with the specifications mentioned in the table below.
- Companies need to submit two bids, a technical bid and a commercial bid, in <u>two separate</u> sealed envelopes. The bids should be submitted no later than 21 days from the date of posting of this tender and by 5 pm on the 21st day or next weekday in case the 21st day falls on a weekend.
- Deviations from the technical specifications requested are allowed. Such deviations must be highlighted and justified. Their acceptance or rejection will be left to the discretion of the technical committee.
- The wafers sought will be used toward academic research at the Centre for Nano Science and Engineering (CeNSE), Indian Institute of Science (IISc). IISc is India's No. 1 academic institution on higher learning and the Center for Nano Science and Engineering is home to one of the best academic fabs in the world.
- The technical response, corresponding to the wafers being offered, should be in the form of a compliance table with at least 5 columns. Serial number in column 1. Each of the numbered technical items below should be addressed in a separate row of the table in column 2. Compliance to this requirement, in Yes/No, deviation from it and justification should be provided in the neighboring columns 3-5. Post the opening of a hard copy of the technical bid the committee will request for a soft copy of the files for further processing. Companies should <u>NOT</u> mail soft copies of the files unless specifically requested for.
- Detailed technical specifications of the wafer being offered should be included.

Bids should be sent to Prof. Digbijoy N Nath, CeNSE, IISc, Bangalore, 560012. Direct all questions concerning this acquisition at digbijoy@iisc.ac.in

| 1. | Primary description | Epitaxial β-Ga ₂ O ₃ wafer on β-Ga ₂ O ₃ substrate |
|--|---|--|
| 2. | Number of wafers required | 1 (One) |
| Specs of the β-Ga ₂ O ₃ substrate on which the epi-stack is realized | | |
| 3. | Size | 4 inch (~ 100 mm) in diameter |
| 4. | Phase/polymorph | β |
| 5. | Doping | Must be > 10 ¹⁹ cm ⁻³ |
| 6. | Dopant | n-type, either Sn or Si dopant, Activated |
| 7. | Orientation | (001) |
| 8. | XRD FWHM | < 400 arcsec |
| 9. | Thickness | > 500 μm |
| 10. | Offset angle | ±1° |
| Specs of the epi-layers of β-Ga ₂ O ₃ | | |
| 11. | Thickness | ~ 10 μm |
| 12. | Dopant type | n-type, Silicon |
| 13. | Doping concentration | ~ 2x10 ¹⁶ cm ⁻³ , activated |
| Common Terms and Conditions | | itions |
| 14. | The wafer must be pre-diced into 1.5 cm x 1.5 cm sizes | |
| 15. | Shipping: The cost of shipping up to IISc should be included. | |